
PRODUCT CHANGE NOTIFICATION NO: E-14-002834
PCN DATE: 03-APR-14

We would like to inform you about the following change(s) to the listed TE Connectivity Product. In case of any further questions about this change(s), please contact your TE Connectivity Sales Engineer. Affected part, drawing and/or specification numbers are listed on the attached sheet(s).

GENERAL PRODUCT DESCRIPTION:

AMPMODU II Breakaway Pin Headers (0.63mm Square Post) - SMD

DESCRIPTION OF CHANGE:

Contact pin base material change from CuSn (Phosphor bronze) to CuZn (Brass). Plating change from min. 0.8microns gold plating to min. 0.7 microns Pd Ni + 0.1 microns gold flash at contact area (Area F).

REASON FOR CHANGE:

Product Improvement. Streamlining of contact base material. Plating process transfer to TE Bydgoszcz. To maintain a competitive position in the market place. Product tested and validated see test report 502-19945.

ESTIMATE DATE:

LAST ORDER DATE:

(OBSOLETE PARTS ONLY)

LAST SHIP DATE:

(OBSOLETE PARTS ONLY)

FIRST DATE TO SHIP CHANGED PARTS: 10-
JUL-2014

(CHANGED PARTS ONLY)

LAST DATE FOR MIXED
SHIPMENTS: NO MIXED SHIPMENTS

(CHANGED PARTS ONLY)

PRODUCT CHANGE NOTIFICATION NO: E-14-002834
PCN DATE: 03-APR-14

PARTS BEING MODIFIED

1-1241050-0

1-1241050-2

1-1241150-0

1-1241150-2

1241050-3

1241050-7

1241050-8

1241150-3

1241150-4

1241150-6

1241150-8

1241150-9

DOCUMENTATION BEING MODIFIED

Customer Drawing
1241050

Customer Drawing
1241150



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1-1241150-0

1-1241150-2

1241050-3

1241050-7

1241050-8

1241150-3

1241150-4

1241150-6

1241150-9

The documents listed below are being modified. Related parts that are not explicitly listed on this PCN are not being modified or discontinued per the PCN. The Last Order Date, Last Ship Date, First Date to Ship Changed Parts, and Last Date for Mixed Shipments apply only to parts explicitly on this PCN under 'PARTS BEING MODIFIED' or 'Parts being Discontinued or available with Alternates heading' (if any).

DOCUMENTATION BEING MODIFIED

CUSTOMER SPECIFIC PARTS
WITHIN THE DOCUMENT

DOCUMENTATION REVISIONS

Customer Drawing
1241050

1-1241050-0

Old Revision: A11

Customer Drawing
1241150

1-1241150-0

Old Revision: B



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Customer Drawing 1241050	1-1241050-0	Old Revision: A11
Customer Drawing 1241150	1-1241150-0	Old Revision: B

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Customer Drawing
1241150

1-1241150-0

Old Revision: B